

Superior high Flux for High Voltage System

Acrich MJT – 5630 Series SAW8KG0B (Cool, Neutral, Warm)







Product Brief

Description

- This surface-mount LED comes in standard package dimension.
 Package Size: 5.6x 3.0x 0.75mm
- It has a substrate made up of a molded plastic reflector sitting on top of a bent lead frame.
- The die is attached within the reflector cavity and the cavity is encapsulated by silicone.
- The package design coupled with careful selection of component materials allow these products to perform with high reliability.

Features and Benefits

- White colored SMT package.
- Pb-free Reflow Soldering
- Suitable for all SMT
- Lead Free and RoHS compliant

Key Applications

- Interior lighting
- General lighting
- Indoor and out door displays
- Architectural / Decorative lighting

Table 1. Product Selection Table

Part Number		ССТ		
Part Number	Color	Min.	Тур.	Max.
SAW8KG0B	Cool White	4,700K	5,600K	7,000K
SAW8KG0B	Neutral White	3,700K	4,200K	4,700K
SAW8KG0B	Warm White	2,600K	3,000K	3,700K



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Performance Characteristics

Table 2. Electro Optical Characteristics, I_F=20mA, T_i = 25°C, RH30%

	CCT (K) [1]		Luminous	Intensity ^[2]	Luminou	ıs Flux ^[3]	CRI
Part Number	CCI (K)1-1	RANK	l _v (cd)	Φν	(lm)	Ra
	Тур.		Min	Max	Min	Max	Min.
		X8	14.8	16.1	45.9	49.9	80
		Y1	16.1	17.4	49.9	53.9	80
	7000~4700	Z4	17.4	19.0	53.9	58.9	80
		J0	19.0	20.3	58.9	62.9	80
		K3	20.3	21.6	62.9	67.0	80
		X8	14.8	16.1	45.1	49.1	80
		Y1	16.1	17.4	49.1	53.1	80
SAW8KG0B	4700~3700	Z4	17.4	19.0	53.1	58.0	80
	_	J0	19.0	20.3	58.0	61.9	80
		K3	20.3	21.6	61.9	65.9	80
		W5	13.5	14.8	40.5	44.4	80
		X8	14.8	16.1	44.4	48.3	80
	3700~2600	Y1	16.1	17.4	48.3	52.2	80
	_	Z4	17.4	19.0	52.2	57.0	80
	_	J0	19.0	20.3	57.0	60.9	80

Notes:

(1) Correlated Color Temperature is derived from the CIE 1931 Chromaticity diagram.

Color coordinate : ±0.005

(2) Seoul Semiconductor maintains a tolerance of $\pm 7\%$ on Intensity and power measurements.

The luminous intensity IV was measured at the peak of the spatial pattern which may not be

aligned with the mechanical axis of the LED package.

(3) Calculated performance values are for reference only.

Performance Characteristics

Table 3. Characteristics, I_F=20mA, T_i = 25°C, RH30%

Danamatan	Common al		Value		11
Parameter	Symbol	Min.	Тур.	Max.	Unit
Forward Current	I _F	=	20	25	mA
Forward Voltage*	I _F	20.7	22	23	V
Reverse Voltage	$V_R (I_R=10 \text{mA})$	0.7	-	-	V
Luminous Intensity*[1] (3700~7000K)	l _v	-	19.0 (58.0)	-	cd
Luminous Intensity*[1] (2600~3700K)	l _v	-	17.5 (52.5)	-	(lm)
Color Rendering Index*	Ra	80	82	90	-
Viewing Angle ^[2]	2Θ _{1/2}	-	115	-	deg.
Power Dissipation **[4]	P _d	-	-	0.58	W
Junction Temperature	T _j	-	-	125	°C
Operating Temperature	T_{opr}	- 40	-	+ 85	°C
Storage Temperature	T _{stg}	- 40	-	+ 100	°C
Thermal resistance [3]	Rθ _{J-S}	-	27	-	K/W
ESD Sensitivity(HBM)	-	5	-	-	KV

Notes:

- (1) The luminous intensity IV was measured at the peak of the spatial pattern which may not be aligned with the mechanical axis of the LED package.
- (2) $2\Theta_{1/2}$ is the off-axis where the luminous intensity is 1/2 of the peak intensity.
- (3) Thermal resistance: RthJS (Junction / solder)
- * Tolerance : VF : ±0.4V, IV : ±7%, Ra : ±2, x,y : ±0.005
- (4) Care is to be taken that power dissipation does not exceed the absolute maximum rating of the product.
- ** LED's properties might be different from suggested values like above and below tables if operation condition will be exceeded our parameter range.

Fig 1. Color Spectrum, I_F =20mA, T_j = 25°C, RH30%

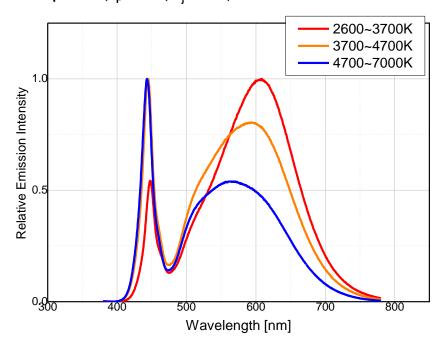


Fig 2. Radiant pattern, $I_F = 20 \text{mA}$

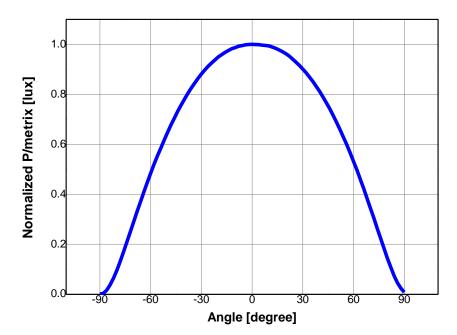


Fig 3. Forward Voltage vs. Forward Current, T_i=25 ℃

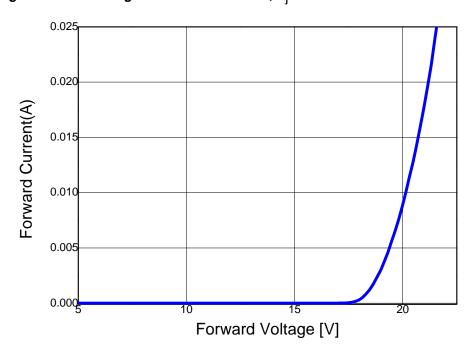


Fig 4. Forward Current vs. Relative Luminous Intensity, T_i=25 ℃

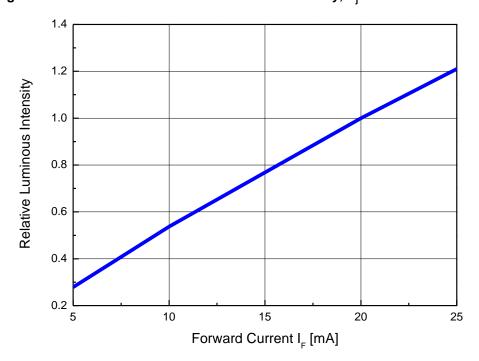


Fig 5. Forward Current vs. CIE X, Y Shift , T_i =25 $^{\circ}$ C

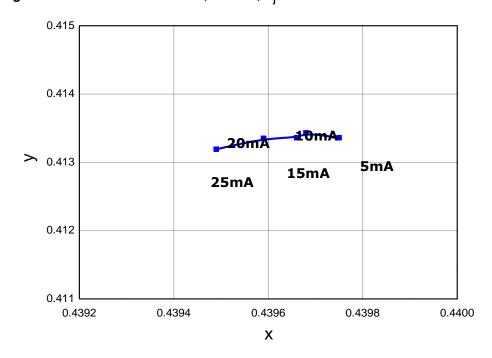


Fig 6. Relative Forward Voltage vs. Junction Temperature, $I_F=20mA$

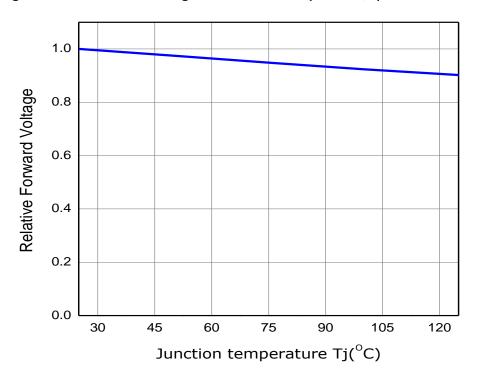


Fig 7. Relative Light Output vs. Junction Temperature, I_F=20mA

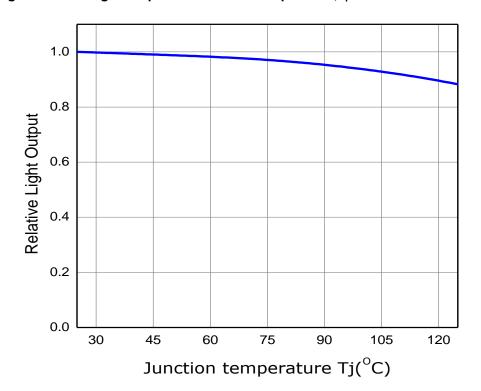


Fig 8. Chromaticity Coordinate vs. Junction Temperature, I_F=20mA

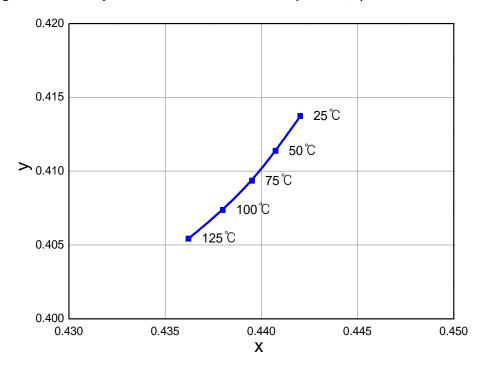
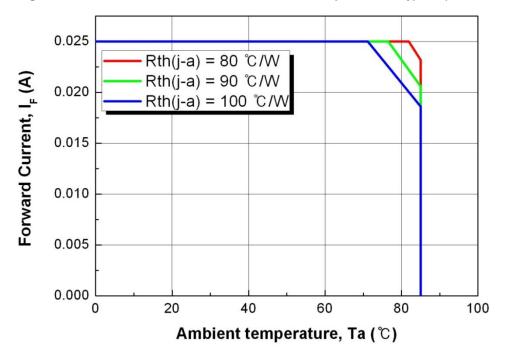


Fig 9. Maximum Forward Current vs. Ambient Temperature, Tj(max.) = 125 ℃, I_F=25mA



Color Bin Structure

Table 4. Bin Code description, I_F=20mA

Part Number	Luminous Intensity I _V (cd)		Color Chromaticity	Typical Fo	ward Vol	tage (V _f)	
	Bin Code	Min.	Max.	Coordinate	Bin Code	Min.	Max.
	W5	13.5	14.8		Α	20.7	21.5
	X8	14.8	16.1		В	21.5	22.2
CANNOKCOD	Y1	16.1	17.4	Defeate near 42	С	22.2	23.0
SAW8KG0B	Z4	17.4	19.0	Refer to page.13			
	J0	19.0	20.3				
	K3	20.3	21.6				

Table 5. Intensity rank distribution

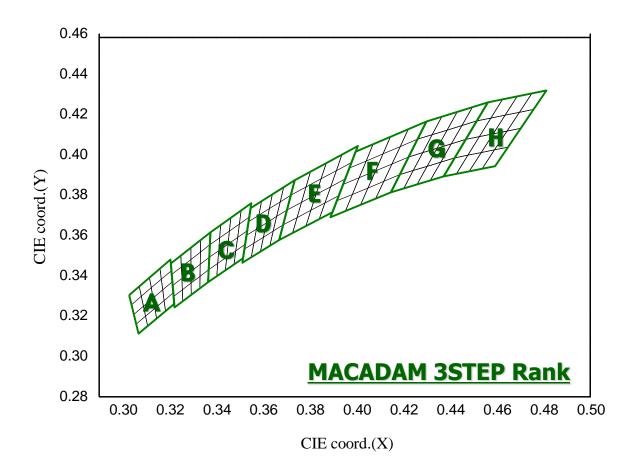
сст	CIE			IV Rank		
6,000 ~ 7,000K	Α	X8	Y1	Z4	J0	K3
5,300 – 6,000K	В	X8	Y1	Z4	J0	K3
4,700 ~ 5,300K	С	X8	Y1	Z4	J0	K3
4,200 ~ 4,700K	D	X8	Y1	Z4	J0	K3
3,700 ~ 4,200K	E	X8	Y1	Z4	J0	K3
3,200 ~ 3,700K	F	W5	X8	Y1	Z4	J0
2,900 ~ 3,200K	G	W5	X8	Y1	Z4	J0
2,600 ~ 2,900K	Н	W5	X8	Y1	Z4	J0

Notes:

(1) All measurements were made under the standardized environment of Seoul Semiconductor In order to ensure availability, single color rank will not be orderable.

Color Bin Structure

CIE Chromaticity Diagram, I_F = 20mA, T_i = 25°C

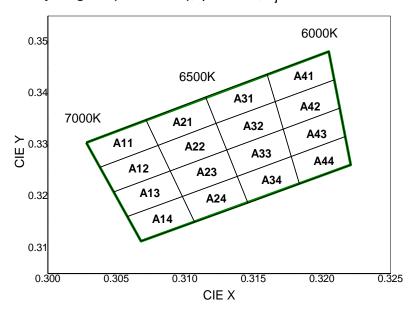


Notes:

- (1) Energy Star binning applied to all 2600~7000K.
- (2) Measurement Uncertainty of the Color Coordinates : \pm 0.005

Color Bin Structure

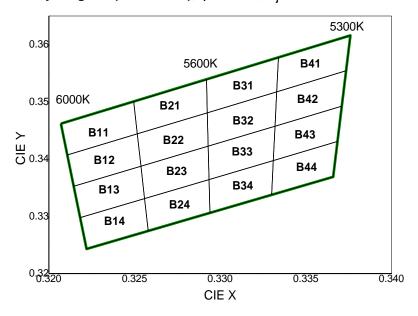
CIE Chromaticity Diagram (Cool White), $I_F = 20$ mA, $T_j = 25$ °C



, A	111	A:	21	A3	1	A	41
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3028	0.3304	0.3072	0.3349	0.3115	0.3393	0.3160	0.3437
0.3038	0.3256	0.3080	0.3299	0.3123	0.3342	0.3166	0.3384
0.3080	0.3299	0.3123	0.3342	0.3166	0.3384	0.3209	0.3426
0.3072	0.3349	0.3115	0.3393	0.3160	0.3437	0.3205	0.3481
, ,	12	A	22	A:	2	A	42
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3038	0.3256	0.3080	0.3299	0.3123	0.3342	0.3166	0.3384
0.3048	0.3209	0.3089	0.3249	0.3131	0.3290	0.3172	0.3331
0.3089	0.3249	0.3131	0.3290	0.3172	0.3331	0.3213	0.3371
0.3080	0.3299	0.3123	0.3342	0.3166	0.3384	0.3209	0.3426
ļ.	\13	A:	23	A3	3	A	43
CIE X	CIE Y	CIE X	23 CIE Y	CIE X	CIE Y	A/ CIE X	43 CIE Y
	•						
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
CIE X 0.3048	CIE Y 0.3209	CIE X 0.3089	CIE Y 0.3249	CIE X 0.3131	CIE Y 0.3290	CIE X 0.3172	CIE Y 0.3331
CIE X 0.3048 0.3058	CIE Y 0.3209 0.3161	CIE X 0.3089 0.3098	CIE Y 0.3249 0.3200	CIE X 0.3131 0.3138	CIE Y 0.3290 0.3239	CIE X 0.3172 0.3178	CIE Y 0.3331 0.3277
CIE X 0.3048 0.3058 0.3098 0.3089	CIE Y 0.3209 0.3161 0.3200	CIE X 0.3089 0.3098 0.3138 0.3131	CIE Y 0.3249 0.3200 0.3239	CIE X 0.3131 0.3138 0.3178	CIE Y 0.3290 0.3239 0.3277 0.3331	CIE X 0.3172 0.3178 0.3217	CIE Y 0.3331 0.3277 0.3316 0.3371
CIE X 0.3048 0.3058 0.3098 0.3089	CIE Y 0.3209 0.3161 0.3200 0.3249	CIE X 0.3089 0.3098 0.3138 0.3131	CIE Y 0.3249 0.3200 0.3239 0.3290	CIE X 0.3131 0.3138 0.3178 0.3172	CIE Y 0.3290 0.3239 0.3277 0.3331	CIE X 0.3172 0.3178 0.3217 0.3213	CIE Y 0.3331 0.3277 0.3316 0.3371
CIE X 0.3048 0.3058 0.3098 0.3089	CIE Y 0.3209 0.3161 0.3200 0.3249	CIE X 0.3089 0.3098 0.3138 0.3131	CIE Y 0.3249 0.3200 0.3239 0.3290	CIE X 0.3131 0.3138 0.3178 0.3172	CIE Y 0.3290 0.3239 0.3277 0.3331	CIE X 0.3172 0.3178 0.3217 0.3213	CIE Y 0.3331 0.3277 0.3316 0.3371
CIE X 0.3048 0.3058 0.3098 0.3089	CIE Y 0.3209 0.3161 0.3200 0.3249 A14 CIE Y	CIE X 0.3089 0.3098 0.3138 0.3131	CIE Y 0.3249 0.3200 0.3239 0.3290 24 CIE Y	CIE X 0.3131 0.3138 0.3178 0.3172 A3	CIE Y 0.3290 0.3239 0.3277 0.3331	CIE X 0.3172 0.3178 0.3217 0.3213 ACCIE X	CIE Y 0.3331 0.3277 0.3316 0.3371 44 CIE Y
CIE X 0.3048 0.3058 0.3098 0.3089 CIE X 0.3058	CIE Y 0.3209 0.3161 0.3200 0.3249 A14 CIE Y 0.3161	CIE X 0.3089 0.3098 0.3138 0.3131 At CIE X 0.3098	CIE Y 0.3249 0.3200 0.3239 0.3290 24 CIE Y 0.3200	CIE X 0.3131 0.3138 0.3178 0.3172 A3 CIE X 0.3138	CIE Y 0.3290 0.3239 0.3277 0.3331 44 CIE Y 0.3239	CIE X 0.3172 0.3178 0.3217 0.3213 A CIE X 0.3178	CIE Y 0.3331 0.3277 0.3316 0.3371 44 CIE Y 0.3277

Color Bin Structure

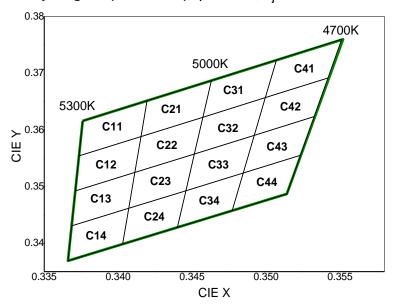
CIE Chromaticity Diagram (Cool White), I_F = 20mA, T_j = 25°C



	311	В	21	В3	31	В	41
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3207	0.3462	0.3250	0.3501	0.3292	0.3539	0.3334	0.3578
0.3211	0.3407	0.3252	0.3444	0.3293	0.3481	0.3333	0.3518
0.3252	0.3444	0.3293	0.3481	0.3333	0.3518	0.3374	0.3554
0.3250	0.3501	0.3292	0.3539	0.3334	0.3578	0.3376	0.3616
ı	312	В	22	В3	32	В	42
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3211	0.3407	0.3252	0.3444	0.3293	0.3481	0.3333	0.3518
0.3215	0.3353	0.3254	0.3388	0.3293	0.3423	0.3332	0.3458
0.3254	0.3388	0.3293	0.3423	0.3332	0.3458	0.3371	0.3493
0.3252	0.3444	0.3293	0.3481	0.3333	0.3518	0.3374	0.3554
	313	В	23	В3	33	В	43
CIE X	CIE Y	CIE X	23 CIE Y	CIE X	CIE Y	CIE X	CIE Y
			•				
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
CIE X 0.3215	CIE Y 0.3353	CIE X 0.3254	CIE Y 0.3388	CIE X 0.3293	CIE Y 0.3423	CIE X 0.3332	CIE Y 0.3458
CIE X 0.3215 0.3218	CIE Y 0.3353 0.3298	CIE X 0.3254 0.3256	CIE Y 0.3388 0.3331	CIE X 0.3293 0.3294	CIE Y 0.3423 0.3364	CIE X 0.3332 0.3331	CIE Y 0.3458 0.3398
CIE X 0.3215 0.3218 0.3256 0.3254	CIE Y 0.3353 0.3298 0.3331	CIE X 0.3254 0.3256 0.3294 0.3293	CIE Y 0.3388 0.3331 0.3364	CIE X 0.3293 0.3294 0.3331	CIE Y 0.3423 0.3364 0.3398 0.3458	CIE X 0.3332 0.3331 0.3369 0.3371	CIE Y 0.3458 0.3398 0.3431
CIE X 0.3215 0.3218 0.3256 0.3254	CIE Y 0.3353 0.3298 0.3331 0.3388	CIE X 0.3254 0.3256 0.3294 0.3293	CIE Y 0.3388 0.3331 0.3364 0.3423	CIE X 0.3293 0.3294 0.3331 0.3332	CIE Y 0.3423 0.3364 0.3398 0.3458	CIE X 0.3332 0.3331 0.3369 0.3371	CIE Y 0.3458 0.3398 0.3431 0.3493
CIE X 0.3215 0.3218 0.3256 0.3254	CIE Y 0.3353 0.3298 0.3331 0.3388	CIE X 0.3254 0.3256 0.3294 0.3293	CIE Y 0.3388 0.3331 0.3364 0.3423	CIE X 0.3293 0.3294 0.3331 0.3332	CIE Y 0.3423 0.3364 0.3398 0.3458	CIE X 0.3332 0.3331 0.3369 0.3371	CIE Y 0.3458 0.3398 0.3431 0.3493
CIE X 0.3215 0.3218 0.3256 0.3254	CIE Y 0.3353 0.3298 0.3331 0.3388 314 CIE Y	CIE X 0.3254 0.3256 0.3294 0.3293 B	CIE Y 0.3388 0.3331 0.3364 0.3423 24 CIE Y	CIE X 0.3293 0.3294 0.3331 0.3332	CIE Y 0.3423 0.3364 0.3398 0.3458	CIE X 0.3332 0.3331 0.3369 0.3371 B	CIE Y 0.3458 0.3398 0.3431 0.3493 44 CIE Y
CIE X 0.3215 0.3218 0.3256 0.3254 CIE X 0.3218	CIE Y 0.3353 0.3298 0.3331 0.3388 314 CIE Y 0.3298	CIE X 0.3254 0.3256 0.3294 0.3293 B CIE X 0.3256	CIE Y 0.3388 0.3331 0.3364 0.3423 24 CIE Y 0.3331	CIE X 0.3293 0.3294 0.3331 0.3332 B3 CIE X 0.3294	CIE Y 0.3423 0.3364 0.3398 0.3458 4 CIE Y 0.3364	CIE X 0.3332 0.3331 0.3369 0.3371 B CIE X 0.3331	CIE Y 0.3458 0.3398 0.3431 0.3493 44 CIE Y 0.3398

Color Bin Structure

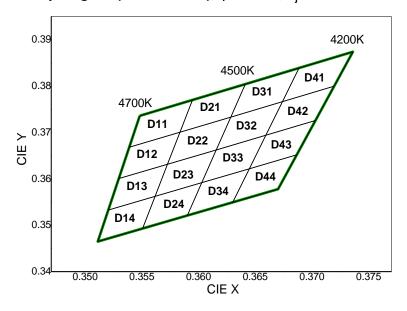
CIE Chromaticity Diagram (Cool White), $I_F = 20mA$, $T_j = 25^{\circ}C$



C.	11	C	21	C3	31	С	41
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3376	0.3616	0.3420	0.3652	0.3463	0.3687	0.3507	0.3724
0.3374	0.3554	0.3415	0.3588	0.3457	0.3622	0.3500	0.3657
0.3415	0.3588	0.3457	0.3622	0.3500	0.3657	0.3542	0.3692
0.3420	0.3652	0.3463	0.3687	0.3507	0.3724	0.3551	0.3760
C	12	C	22	C3	32	С	42
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3374	0.3554	0.3415	0.3588	0.3457	0.3622	0.3500	0.3657
0.3371	0.3493	0.3411	0.3525	0.3452	0.3558	0.3492	0.3591
0.3411	0.3525	0.3452	0.3558	0.3492	0.3591	0.3533	0.3624
0.3415	0.3588	0.3457	0.3622	0.3500	0.3657	0.3542	0.3692
C.	13	C	23	C3	33	С	43
CIE X	13 CIE Y	CIE X	23 CIE Y	CIE X	CIE Y	CIE X	CIE Y
							•
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
CIE X 0.3371	CIE Y 0.3493	CIE X 0.3411	CIE Y 0.3525	CIE X 0.3452	CIE Y 0.3558	CIE X 0.3492	CIE Y 0.3591
CIE X 0.3371 0.3369	CIE Y 0.3493 0.3431	CIE X 0.3411 0.3407	CIE Y 0.3525 0.3462	CIE X 0.3452 0.3446	CIE Y 0.3558 0.3493	CIE X 0.3492 0.3485	CIE Y 0.3591 0.3524
CIE X 0.3371 0.3369 0.3407	CIE Y 0.3493 0.3431 0.3462 0.3525	CIE X 0.3411 0.3407 0.3446 0.3452	CIE Y 0.3525 0.3462 0.3493	CIE X 0.3452 0.3446 0.3485	CIE Y 0.3558 0.3493 0.3524 0.3591	CIE X 0.3492 0.3485 0.3523 0.3533	CIE Y 0.3591 0.3524 0.3555
CIE X 0.3371 0.3369 0.3407 0.3411	CIE Y 0.3493 0.3431 0.3462 0.3525	CIE X 0.3411 0.3407 0.3446 0.3452	CIE Y 0.3525 0.3462 0.3493 0.3558	CIE X 0.3452 0.3446 0.3485 0.3492	CIE Y 0.3558 0.3493 0.3524 0.3591	CIE X 0.3492 0.3485 0.3523 0.3533	CIE Y 0.3591 0.3524 0.3555 0.3624
CIE X 0.3371 0.3369 0.3407 0.3411	CIE Y 0.3493 0.3431 0.3462 0.3525	CIE X 0.3411 0.3407 0.3446 0.3452	CIE Y 0.3525 0.3462 0.3493 0.3558	CIE X 0.3452 0.3446 0.3485 0.3492	CIE Y 0.3558 0.3493 0.3524 0.3591	CIE X 0.3492 0.3485 0.3523 0.3533	CIE Y 0.3591 0.3524 0.3555 0.3624
CIE X 0.3371 0.3369 0.3407 0.3411 CIE X	CIE Y 0.3493 0.3431 0.3462 0.3525	CIE X 0.3411 0.3407 0.3446 0.3452	CIE Y 0.3525 0.3462 0.3493 0.3558 24 CIE Y	CIE X 0.3452 0.3446 0.3485 0.3492	CIE Y 0.3558 0.3493 0.3524 0.3591 44 CIE Y	CIE X 0.3492 0.3485 0.3523 0.3533 CIE X	CIE Y 0.3591 0.3524 0.3555 0.3624 44 CIE Y
CIE X 0.3371 0.3369 0.3407 0.3411 CIE X 0.3369	CIE Y 0.3493 0.3431 0.3462 0.3525 14 CIE Y 0.3431	CIE X 0.3411 0.3407 0.3446 0.3452 CIE X 0.3407	CIE Y 0.3525 0.3462 0.3493 0.3558 24 CIE Y 0.3462	CIE X 0.3452 0.3446 0.3485 0.3492 CIE X 0.3446	CIE Y 0.3558 0.3493 0.3524 0.3591 64 CIE Y 0.3493	CIE X 0.3492 0.3485 0.3523 0.3533 CIE X 0.3485	CIE Y 0.3591 0.3524 0.3555 0.3624 44 CIE Y 0.3524
CIE X 0.3371 0.3369 0.3407 0.3411 CIE X 0.3369 0.3366	CIE Y 0.3493 0.3431 0.3462 0.3525 14 CIE Y 0.3431 0.3369	CIE X 0.3411 0.3407 0.3446 0.3452 CIE X 0.3407 0.3403	CIE Y 0.3525 0.3462 0.3493 0.3558 24 CIE Y 0.3462 0.3399	CIE X 0.3452 0.3446 0.3485 0.3492 C3 CIE X 0.3446 0.3440	CIE Y 0.3558 0.3493 0.3524 0.3591 44 CIE Y 0.3493 0.3428	CIE X 0.3492 0.3485 0.3523 0.3533 CIE X 0.3485 0.3477	CIE Y 0.3591 0.3524 0.3555 0.3624 44 CIE Y 0.3524 0.3458

Color Bin Structure

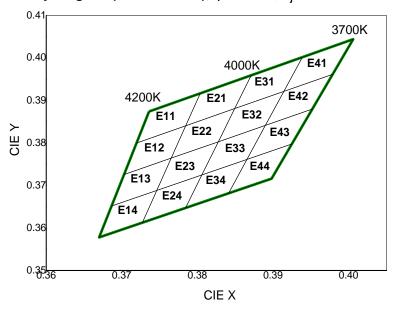
CIE Chromaticity Diagram (Neutral White), $I_F = 20$ mA, $T_j = 25$ °C



	011	D:	21	D3	31	D	41
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3548	0.3736	0.3595	0.3770	0.3641	0.3804	0.3689	0.3839
0.3539	0.3668	0.3584	0.3701	0.3628	0.3733	0.3674	0.3767
0.3584	0.3701	0.3628	0.3733	0.3674	0.3767	0.3720	0.3800
0.3595	0.3770	0.3641	0.3804	0.3689	0.3839	0.3736	0.3874
	012	D	22	D3	32	D	42
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3539	0.3668	0.3584	0.3701	0.3628	0.3733	0.3674	0.3767
0.3530	0.3601	0.3573	0.3632	0.3616	0.3663	0.3659	0.3694
0.3573	0.3632	0.3616	0.3663	0.3659	0.3694	0.3703	0.3726
0.3584	0.3701	0.3628	0.3733	0.3674	0.3767	0.3720	0.3800
	013	D	23	D3	33	D ₁	43
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	43 CIE Y
			•				
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
CIE X 0.3530	CIE Y 0.3601	CIE X 0.3573	CIE Y 0.3632	CIE X 0.3616	CIE Y 0.3663	CIE X 0.3659	CIE Y 0.3694
CIE X 0.3530 0.3520	CIE Y 0.3601 0.3533	CIE X 0.3573 0.3562	CIE Y 0.3632 0.3562	CIE X 0.3616 0.3603	CIE Y 0.3663 0.3592	CIE X 0.3659 0.3645	CIE Y 0.3694 0.3622
CIE X 0.3530 0.3520 0.3562 0.3573	CIE Y 0.3601 0.3533 0.3562	CIE X 0.3573 0.3562 0.3603 0.3616	CIE Y 0.3632 0.3562 0.3592	CIE X 0.3616 0.3603 0.3645	CIE Y 0.3663 0.3592 0.3622 0.3694	CIE X 0.3659 0.3645 0.3687 0.3703	CIE Y 0.3694 0.3622 0.3652
CIE X 0.3530 0.3520 0.3562 0.3573	CIE Y 0.3601 0.3533 0.3562 0.3632	CIE X 0.3573 0.3562 0.3603 0.3616	CIE Y 0.3632 0.3562 0.3592 0.3663	CIE X 0.3616 0.3603 0.3645 0.3659	CIE Y 0.3663 0.3592 0.3622 0.3694	CIE X 0.3659 0.3645 0.3687 0.3703	CIE Y 0.3694 0.3622 0.3652 0.3726
CIE X 0.3530 0.3520 0.3562 0.3573	CIE Y 0.3601 0.3533 0.3562 0.3632	CIE X 0.3573 0.3562 0.3603 0.3616	CIE Y 0.3632 0.3562 0.3592 0.3663	CIE X 0.3616 0.3603 0.3645 0.3659	CIE Y 0.3663 0.3592 0.3622 0.3694	CIE X 0.3659 0.3645 0.3687 0.3703	CIE Y 0.3694 0.3622 0.3652 0.3726
CIE X 0.3530 0.3520 0.3562 0.3573	CIE Y 0.3601 0.3533 0.3562 0.3632 014 CIE Y	CIE X 0.3573 0.3562 0.3603 0.3616	CIE Y 0.3632 0.3562 0.3592 0.3663 24 CIE Y	CIE X 0.3616 0.3603 0.3645 0.3659 D3	CIE Y 0.3663 0.3592 0.3622 0.3694 CIE Y	CIE X 0.3659 0.3645 0.3687 0.3703	CIE Y 0.3694 0.3622 0.3652 0.3726
CIE X 0.3530 0.3520 0.3562 0.3573 CIE X 0.3520	CIE Y 0.3601 0.3533 0.3562 0.3632 014 CIE Y 0.3533	CIE X 0.3573 0.3562 0.3603 0.3616 CIE X 0.3562	CIE Y 0.3632 0.3562 0.3592 0.3663 24 CIE Y 0.3562	CIE X 0.3616 0.3603 0.3645 0.3659 D3 CIE X 0.3603	CIE Y 0.3663 0.3592 0.3622 0.3694 34 CIE Y 0.3592	CIE X 0.3659 0.3645 0.3687 0.3703 CIE X 0.3645	CIE Y 0.3694 0.3622 0.3652 0.3726 44 CIE Y 0.3622

Color Bin Structure

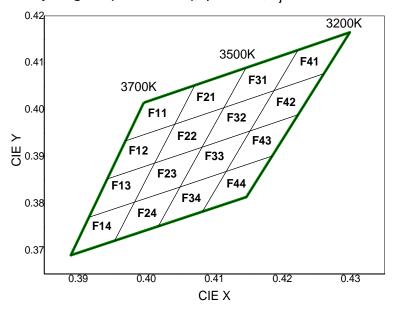
CIE Chromaticity Diagram (Neutral White), $I_F = 20$ mA, $T_j = 25$ °C



E11 E	21	E3	31	E4	41
CIE X CIE Y CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3736 0.3874 0.3804	0.3917	0.3871	0.3959	0.3939	0.4002
0.3720 0.3800 0.3784	0.3841	0.3849	0.3881	0.3914	0.3922
0.3784 0.3841 0.3849	0.3881	0.3914	0.3922	0.3979	0.3962
0.3804 0.3917 0.3871	0.3959	0.3939	0.4002	0.4006	0.4044
E12 E2	22	E3	32	E-	42
CIE X CIE Y CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3720 0.3800 0.3784	0.3841	0.3849	0.3881	0.3914	0.3922
0.3703	0.3765	0.3828	0.3803	0.3890	0.3842
0.3765 0.3765 0.3828	0.3803	0.3890	0.3842	0.3952	0.3880
0.3784 0.3841 0.3849	0.3881	0.3914	0.3922	0.3979	0.3962
0.3704 0.3041 0.3049					
	23	E3	33	E	43
		CIE X	CIE Y	CIE X	43 CIE Y
E13 E2	23		•		
E13 E5	23 CIE Y	CIE X	CIE Y	CIE X	CIE Y
E13 E2 CIE X CIE Y CIE X 0.3703 0.3726 0.3765	CIE Y 0.3765	CIE X 0.3828	CIE Y 0.3803	CIE X 0.3890	CIE Y 0.3842
E13 E2 CIE X CIE Y CIE X 0.3703 0.3726 0.3765 0.3687 0.3652 0.3746	CIE Y 0.3765 0.3689	CIE X 0.3828 0.3806	CIE Y 0.3803 0.3725	CIE X 0.3890 0.3865	CIE Y 0.3842 0.3762
E13 E2 CIE X CIE Y CIE X 0.3703 0.3726 0.3765 0.3687 0.3652 0.3746 0.3746 0.3689 0.3806 0.3765 0.3765 0.3828	CIE Y 0.3765 0.3689 0.3725	CIE X 0.3828 0.3806 0.3865	CIE Y 0.3803 0.3725 0.3762 0.3842	CIE X 0.3890 0.3865 0.3925	CIE Y 0.3842 0.3762 0.3798 0.3880
E13 E2 CIE X CIE Y CIE X 0.3703 0.3726 0.3765 0.3687 0.3652 0.3746 0.3746 0.3689 0.3806 0.3765 0.3765 0.3828	CIE Y 0.3765 0.3689 0.3725 0.3803	CIE X 0.3828 0.3806 0.3865 0.3890	CIE Y 0.3803 0.3725 0.3762 0.3842	CIE X 0.3890 0.3865 0.3925 0.3952	CIE Y 0.3842 0.3762 0.3798 0.3880
E13 E5 CIE X CIE Y CIE X 0.3703 0.3726 0.3765 0.3687 0.3652 0.3746 0.3746 0.3689 0.3806 0.3765 0.3765 0.3828	CIE Y 0.3765 0.3689 0.3725 0.3803	CIE X 0.3828 0.3806 0.3865 0.3890	CIE Y 0.3803 0.3725 0.3762 0.3842	CIE X 0.3890 0.3865 0.3925 0.3952	CIE Y 0.3842 0.3762 0.3798 0.3880
E13 E3 CIE X CIE Y CIE X 0.3703 0.3726 0.3765 0.3687 0.3652 0.3746 0.3746 0.3689 0.3806 0.3765 0.3765 0.3828 E14 E2 CIE X CIE Y CIE X	CIE Y 0.3765 0.3689 0.3725 0.3803 24 CIE Y	CIE X 0.3828 0.3806 0.3865 0.3890 EX	CIE Y 0.3803 0.3725 0.3762 0.3842 CIE Y	CIE X 0.3890 0.3865 0.3925 0.3952	CIE Y 0.3842 0.3762 0.3798 0.3880 44 CIE Y
E13 E5 CIE X CIE Y CIE X 0.3703 0.3726 0.3765 0.3687 0.3652 0.3746 0.3746 0.3689 0.3806 0.3765 0.3765 0.3828 E14 E5 CIE X CIE Y CIE X 0.3687 0.3652 0.3746	CIE Y 0.3765 0.3689 0.3725 0.3803 24 CIE Y 0.3689	CIE X 0.3828 0.3806 0.3865 0.3890 ES CIE X 0.3806	CIE Y 0.3803 0.3725 0.3762 0.3842 4 CIE Y 0.3725	CIE X 0.3890 0.3865 0.3925 0.3952 EACURE X 0.3865	CIE Y 0.3842 0.3762 0.3798 0.3880 44 CIE Y 0.3762

Color Bin Structure

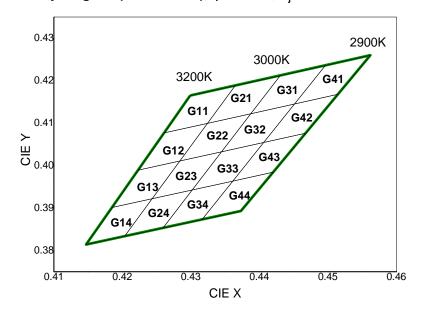
CIE Chromaticity Diagram (Warm White), $I_F = 20$ mA, $T_j = 25$ °C



F	11	F.	21	F3	31	F-	41
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3996	0.4015	0.4071	0.4052	0.4146	0.4089	0.4223	0.4127
0.3969	0.3934	0.4042	0.3969	0.4114	0.4005	0.4187	0.4041
0.4042	0.3969	0.4114	0.4005	0.4187	0.4041	0.4261	0.4077
0.4071	0.4052	0.4146	0.4089	0.4223	0.4127	0.4299	0.4165
F	12	F:	22	F3	32	F	42
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.3969	0.3934	0.4042	0.3969	0.4114	0.4005	0.4187	0.4041
0.3943	0.3853	0.4012	0.3886	0.4082	0.3920	0.4152	0.3955
0.4012	0.3886	0.4082	0.3920	0.4152	0.3955	0.4223	0.3990
0.4042	0.3969	0.4114	0.4005	0.4187	0.4041	0.4261	0.4077
F	13	F.	23	F3	3	F	43
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	43 CIE Y
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
CIE X 0.3943	CIE Y 0.3853	CIE X 0.4012	CIE Y 0.3886	CIE X 0.4082	CIE Y 0.3920	CIE X 0.4152	CIE Y 0.3955
CIE X 0.3943 0.3916	CIE Y 0.3853 0.3771	CIE X 0.4012 0.3983	CIE Y 0.3886 0.3803	CIE X 0.4082 0.4049	CIE Y 0.3920 0.3836	CIE X 0.4152 0.4117	CIE Y 0.3955 0.3869
CIE X 0.3943 0.3916 0.3983 0.4012	CIE Y 0.3853 0.3771 0.3803	CIE X 0.4012 0.3983 0.4049 0.4082	CIE Y 0.3886 0.3803 0.3836	CIE X 0.4082 0.4049 0.4117	CIE Y 0.3920 0.3836 0.3869 0.3955	CIE X 0.4152 0.4117 0.4185 0.4223	CIE Y 0.3955 0.3869 0.3902
CIE X 0.3943 0.3916 0.3983 0.4012	CIE Y 0.3853 0.3771 0.3803 0.3886	CIE X 0.4012 0.3983 0.4049 0.4082	CIE Y 0.3886 0.3803 0.3836 0.3920	CIE X 0.4082 0.4049 0.4117 0.4152	CIE Y 0.3920 0.3836 0.3869 0.3955	CIE X 0.4152 0.4117 0.4185 0.4223	CIE Y 0.3955 0.3869 0.3902 0.3990
CIE X 0.3943 0.3916 0.3983 0.4012	CIE Y 0.3853 0.3771 0.3803 0.3886	CIE X 0.4012 0.3983 0.4049 0.4082	CIE Y 0.3886 0.3803 0.3836 0.3920	CIE X 0.4082 0.4049 0.4117 0.4152	CIE Y 0.3920 0.3836 0.3869 0.3955	CIE X 0.4152 0.4117 0.4185 0.4223	CIE Y 0.3955 0.3869 0.3902 0.3990
CIE X 0.3943 0.3916 0.3983 0.4012	CIE Y 0.3853 0.3771 0.3803 0.3886 14 CIE Y	CIE X 0.4012 0.3983 0.4049 0.4082	CIE Y 0.3886 0.3803 0.3836 0.3920 24 CIE Y	CIE X 0.4082 0.4049 0.4117 0.4152 F8	CIE Y 0.3920 0.3836 0.3869 0.3955	CIE X 0.4152 0.4117 0.4185 0.4223 FA	CIE Y 0.3955 0.3869 0.3902 0.3990 44 CIE Y
CIE X 0.3943 0.3916 0.3983 0.4012 F CIE X 0.3916	CIE Y 0.3853 0.3771 0.3803 0.3886 14 CIE Y 0.3771	CIE X 0.4012 0.3983 0.4049 0.4082 F: CIE X 0.3983	CIE Y 0.3886 0.3803 0.3836 0.3920 24 CIE Y 0.3803	CIE X 0.4082 0.4049 0.4117 0.4152 F3 CIE X 0.4049	CIE Y 0.3920 0.3836 0.3869 0.3955 4 CIE Y 0.3836	CIE X 0.4152 0.4117 0.4185 0.4223 F2 CIE X 0.4117	CIE Y 0.3955 0.3869 0.3902 0.3990 44 CIE Y 0.3869

Color Bin Structure

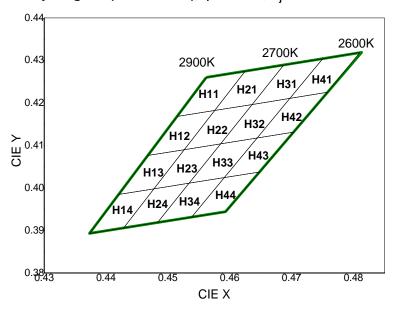
CIE Chromaticity Diagram (Warm White), $I_F = 20$ mA, $T_j = 25$ °C



G41
CIE X CIE Y
2 0.4496 0.4236
2 0.4451 0.4145
0.4514 0.4168
0.4562 0.4260
G42
CIE X CIE Y
0.4451 0.4145
0.4406 0.4055
0.4468 0.4077
0.4515 0.4168
G43 0.4515 0.4168
G43
G43 CIE X CIE Y
CIE X CIE Y 0.4406 0.4055
G43 CIE X CIE Y 0.4406 0.4055 0.4361 0.3964
CIE X CIE Y 0.4406 0.4055 0.4361 0.3964 0.4420 0.3985
G43 CIE X CIE Y 0.4406 0.4055 0.4361 0.3964 0.4420 0.3985 0.4468 0.4077
G43 CIE X CIE Y 0.4406 0.4055 0.4361 0.3964 0.4420 0.3985 0.4468 0.4077
G43 CIE X CIE Y 0.4406 0.4055 0.4361 0.3964 0.4420 0.3985 0.4468 0.4077 G44 CIE X CIE Y
G43 CIE X CIE Y 0.4406 0.4055 0.4361 0.3964 0.4420 0.3985 0.4468 0.4077 G44 CIE X CIE Y 0.4361 0.3964

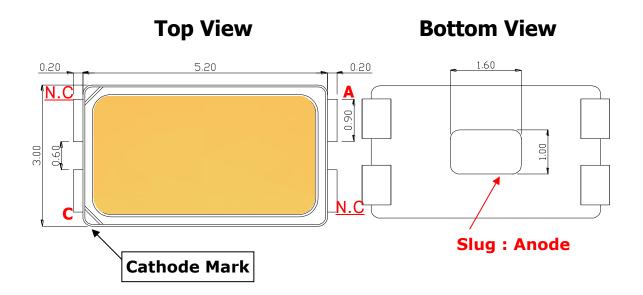
Color Bin Structure

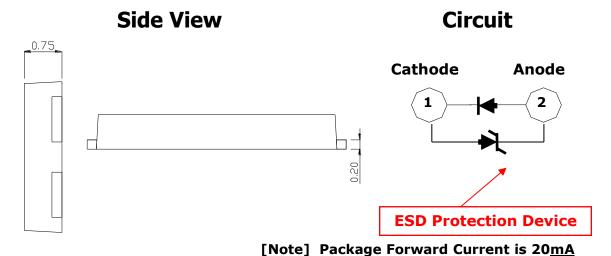
CIE Chromaticity Diagram (Warm White), $I_F = 20$ mA, $T_j = 25$ °C



H ²	11	H	21	Ha	31	H	41
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.4562	0.4260	0.4625	0.4275	0.4687	0.4289	0.4750	0.4304
0.4515	0.4168	0.4575	0.4182	0.4636	0.4197	0.4697	0.4211
0.4575	0.4182	0.4636	0.4197	0.4697	0.4211	0.4758	0.4225
0.4625	0.4275	0.4687	0.4289	0.4750	0.4304	0.4810	0.4319
H ⁻	H12		22	H	32	H	42
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
0.4515	0.4168	0.4575	0.4182	0.4636	0.4197	0.4697	0.4211
0.4468	0.4077	0.4526	0.4090	0.4585	0.4104	0.4644	0.4118
0.4526	0.4090	0.4585	0.4104	0.4644	0.4118	0.4703	0.4132
0.4575	0.4182	0.4636	0.4197	0.4697	0.4211	0.4758	0.4225
H ²	13	H:	23	H3	33	H ₄	43
CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y	CIE X	CIE Y
CIE X 0.4468	CIE Y 0.4077	CIE X 0.4526	CIE Y 0.4090	CIE X 0.4585	CIE Y 0.4104	CIE X 0.4644	CIE Y 0.4118
			_		_		_
0.4468	0.4077	0.4526	0.4090	0.4585	0.4104	0.4644	0.4118
0.4468 0.4420	0.4077 0.3985	0.4526 0.4477	0.4090 0.3998	0.4585 0.4534	0.4104 0.4012	0.4644 0.4591	0.4118 0.4025
0.4468 0.4420 0.4477	0.4077 0.3985 0.3998 0.4090	0.4526 0.4477 0.4534	0.4090 0.3998 0.4012 0.4104	0.4585 0.4534 0.4591	0.4104 0.4012 0.4025 0.4118	0.4644 0.4591 0.4648	0.4118 0.4025 0.4038 0.4132
0.4468 0.4420 0.4477 0.4526	0.4077 0.3985 0.3998 0.4090	0.4526 0.4477 0.4534 0.4585	0.4090 0.3998 0.4012 0.4104	0.4585 0.4534 0.4591 0.4644	0.4104 0.4012 0.4025 0.4118	0.4644 0.4591 0.4648 0.4703	0.4118 0.4025 0.4038 0.4132
0.4468 0.4420 0.4477 0.4526	0.4077 0.3985 0.3998 0.4090	0.4526 0.4477 0.4534 0.4585	0.4090 0.3998 0.4012 0.4104	0.4585 0.4534 0.4591 0.4644	0.4104 0.4012 0.4025 0.4118	0.4644 0.4591 0.4648 0.4703	0.4118 0.4025 0.4038 0.4132
0.4468 0.4420 0.4477 0.4526 H ²	0.4077 0.3985 0.3998 0.4090 14	0.4526 0.4477 0.4534 0.4585 H:	0.4090 0.3998 0.4012 0.4104 CIE Y	0.4585 0.4534 0.4591 0.4644 H3	0.4104 0.4012 0.4025 0.4118 34 CIE Y	0.4644 0.4591 0.4648 0.4703	0.4118 0.4025 0.4038 0.4132 44 CIE Y
0.4468 0.4420 0.4477 0.4526 H' CIE X 0.4420	0.4077 0.3985 0.3998 0.4090 14 CIE Y 0.3985	0.4526 0.4477 0.4534 0.4585 H: CIE X 0.4477	0.4090 0.3998 0.4012 0.4104 24 CIE Y 0.3998	0.4585 0.4534 0.4591 0.4644 H3 CIE X 0.4534	0.4104 0.4012 0.4025 0.4118 34 CIE Y 0.4012	0.4644 0.4591 0.4648 0.4703 H4 CIE X 0.4591	0.4118 0.4025 0.4038 0.4132 44 CIE Y 0.4025
0.4468 0.4420 0.4477 0.4526 H** CIE X 0.4420 0.4373	0.4077 0.3985 0.3998 0.4090 14 CIE Y 0.3985 0.3893	0.4526 0.4477 0.4534 0.4585 H: CIE X 0.4477 0.4428	0.4090 0.3998 0.4012 0.4104 24 CIE Y 0.3998 0.3906	0.4585 0.4534 0.4591 0.4644 CIE X 0.4534 0.4483	0.4104 0.4012 0.4025 0.4118 44 CIE Y 0.4012 0.3919	0.4644 0.4591 0.4648 0.4703 H- CIE X 0.4591 0.4538	0.4118 0.4025 0.4038 0.4132 44 CIE Y 0.4025 0.3932

Mechanical Dimensions

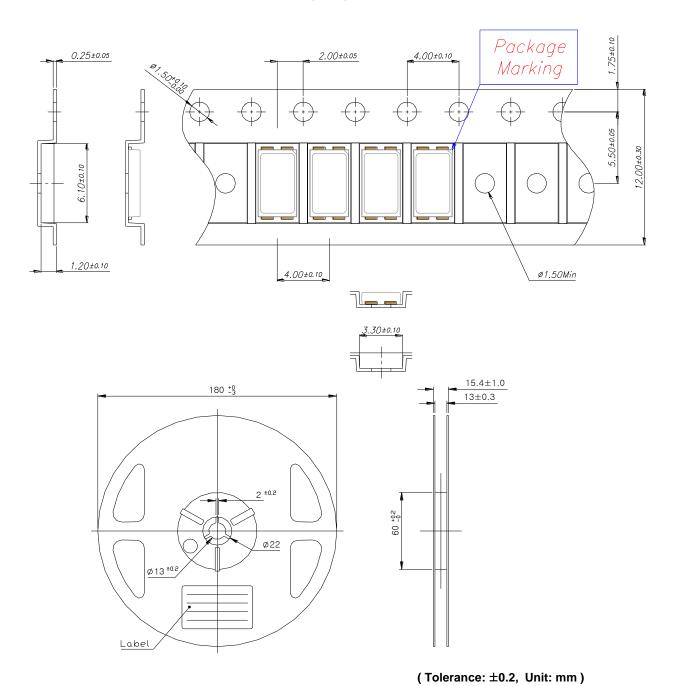




Notes:

- (1) All dimensions are in millimeters.
- (2) Scale: none
- (3) Undefined tolerance is ± 0.1 mm

Emitter Tape & Reel Packaging

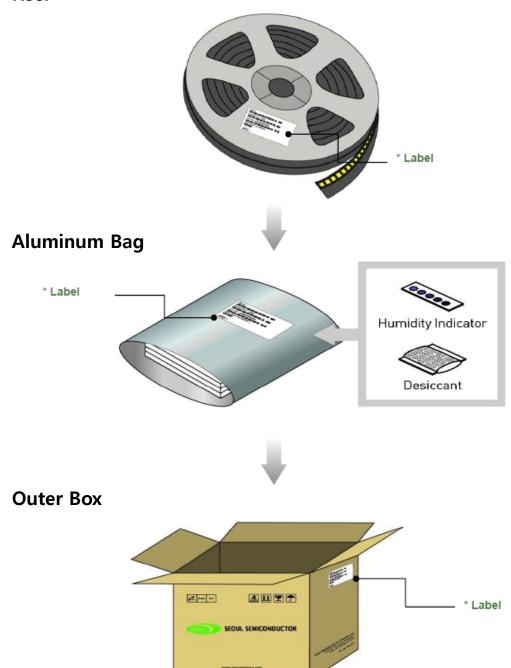


Notes:

- (1) Quantity: 3,500pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be $\pm 0.2 \text{mm}$
- (3) Adhesion Strength of Cover Tape: Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape
- (4) Package: P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof package

Emitter Tape & Reel Packaging

Reel



Product Nomenclature

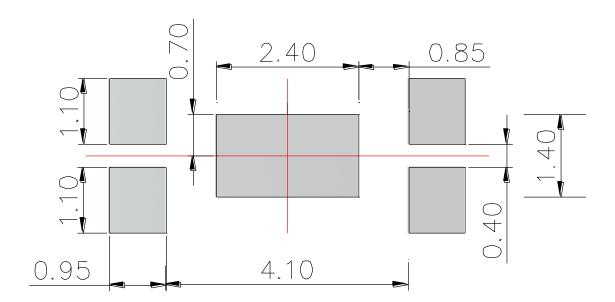
Table 6. Part Numbering System : $X_1X_2X_3X_4X_5X_6X_7X_8$

Part Number Code	Description	Part Number	Value
X ₁	Company	S	SSC
X ₂	Acrich LED series	А	
X ₃ X ₄	Color Specification	W8	CRI 80
X ₅	Package series	K	K series
X ₆	Voltage	G	
X ₇	PCB type	0	Emitter
X ₈	Revision	В	rev1

Table 7. Lot Numbering System $: Y_1Y_2Y_3Y_4Y_5Y_6Y_7Y_8Y_9Y_{10} - Y_{11}Y_{12}Y_{13}Y_{14}Y_{15}Y_{16}Y_{17}$

Lot Number Code	Description	Lot Number	Value
Y ₁ Y ₂	Year		
Y ₃	Month		
Y ₄ Y ₅	Day		
Y ₆	Top View LED series		
Y ₇ Y ₈ Y ₉ Y ₁₀	Mass order		
Y ₁₁ Y ₁₂ Y ₁₃ Y ₁₄ Y ₁₅ Y ₁₆ Y ₁₇	Internal Number		

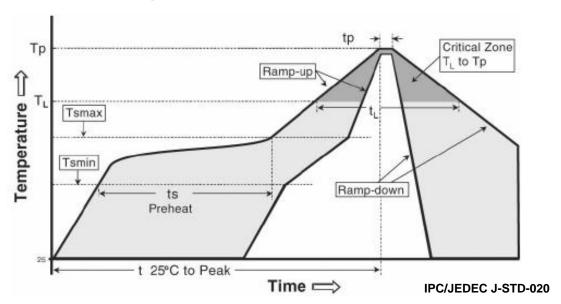
Recommended Solder Pad



Notes:

- (1) All dimensions are in millimeters.
- (2) Scale: none
- (3) This drawing without tolerances are for reference only
- (4) Undefined tolerance is ± 0.1 mm

Reflow Soldering Characteristics



Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate (Tsmax to Tp)	3° C/second max.	3° C/second max.
Preheat - Temperature Min (Tsmin) - Temperature Max (Tsmax) - Time (Tsmin to Tsmax) (ts)	100 °C 150 °C 60-120 seconds	150 °C 200 °C 60-180 seconds
Time maintained above: - Temperature (TL) - Time (tL)	183 °C 60-150 seconds	217 °C 60-150 seconds
Peak Temperature (Tp)	215℃	260℃
Time within 5°C of actual Peak Temperature (tp)2	10-30 seconds	20-40 seconds
Ramp-down Rate	6 °C/second max.	6 °C/second max.
Time 25°C to Peak Temperature	6 minutes max.	8 minutes max.

Caution

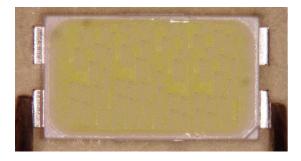
- (1) Reflow soldering is recommended not to be done more than two times. In the case of more than 24 hours passed soldering after first, LEDs will be damaged.
- (2) Repairs should not be done after the LEDs have been soldered. When repair is unavoidable, suitable tools must be used.
- (3) Die slug is to be soldered.
- (4) When soldering, do not put stress on the LEDs during heating.
- (5) After soldering, do not warp the circuit board.

Handling of Silicone Resin for LEDs

(1) During processing, mechanical stress on the surface should be minimized as much as possible. Sharp objects of all types should not be used to pierce the sealing compound.



(2) In general, LEDs should only be handled from the side. By the way, this also applies to LEDs without a silicone sealant, since the surface can also become scratched.



- (3) When populating boards in SMT production, there are basically no restrictions regarding the form of the pick and place nozzle, except that mechanical pressure on the surface of the resin must be prevented. This is assured by choosing a pick and place nozzle which is larger than the LED's reflector area.
- (4) Silicone differs from materials conventionally used for the manufacturing of LEDs. These conditions must be considered during the handling of such devices. Compared to standard encapsulants, silicone is generally softer, and the surface is more likely to attract dust.

As mentioned previously, the increased sensitivity to dust requires special care during processing. In cases where a minimal level of dirt and dust particles cannot be guaranteed, a suitable cleaning solution must be applied to the surface after the soldering of components.

- (5) SSC suggests using isopropyl alcohol for cleaning. In case other solvents are used, it must be assured that these solvents do not dissolve the package or resin.
- Ultrasonic cleaning is not recommended. Ultrasonic cleaning may cause damage to the LED.
- (6) Please do not mold this product into another resin (epoxy, urethane, etc) and do not handle this product with acid or sulfur material in sealed space.
- (7) Avoid leaving fingerprints on silicone resin parts.

Precaution for Use

(1) Storage

To avoid the moisture penetration, we recommend store in a dry box with a desiccant.

The recommended storage temperature range is 5 $^{\circ}$ C to 30 $^{\circ}$ C and a maximum humidity of RH50%.

(2) Use Precaution after Opening the Packaging

Use proper SMT techniques when the LED is to be soldered dipped as separation of the lens may affect the light output efficiency.

Pay attention to the following:

- a. Recommend conditions after opening the package
 - Sealing
 - Temperature : 5 ~ 30 °C Humidity : less than RH60%
- b. If the package has been opened more than 4 week(MSL_2a) or the color of the desiccant changes, components should be dried for 10-12hr at $60\pm5\,^{\circ}$ C
- (3) Do not apply mechanical force or excess vibration during the cooling process to normal temperature after soldering.
- (4) Do not rapidly cool device after soldering.
- (5) Components should not be mounted on warped (non coplanar) portion of PCB.
- (6) Radioactive exposure is not considered for the products listed here in.
- (7) Gallium arsenide is used in some of the products listed in this publication.

These products are dangerous if they are burned or shredded in the process of disposal.

It is also dangerous to drink the liquid or inhale the gas generated by such products when chemically disposed of.

- (8) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA (Isopropyl Alcohol) should be used.
- (9) When the LEDs are in operation the maximum current should be decided after measuring the package temperature.
- (10) The appearance and specifications of the product may be modified for improvement without notice.
- (11) Long time exposure of sunlight or occasional UV exposure will cause lens discoloration.
- (12) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy.

The result can be a significant loss of light output from the fixture.

Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues.

- (13) Attaching LEDs, do not use adhesives that outgas organic vapor.
- (14) The driving circuit must be designed to allow forward voltage only when it is ON or OFF.

If the reverse voltage is applied to LED, migration can be generated resulting in LED damage.

Precaution for Use

(15) Similar to most Solid state devices;

LEDs are sensitive to Electro-Static Discharge (ESD) and Electrical Over Stress (EOS). Below is a list of suggestions that Seoul Semiconductor purposes to minimize these effects.

a. ESD (Electro Static Discharge)

Electrostatic discharge (ESD) is the defined as the release of static electricity when two objects come into contact. While most ESD events are considered harmless, it can be an expensive problem in many industrial environments during production and storage. The damage from ESD to an LEDs may cause the product to demonstrate unusual characteristics such as:

- Increase in reverse leakage current
- Lowered turn-on voltage
- Abnormal emissions from the LED at low current

The following Recommendations are suggested to help minimize the potential for an ESD event:

- One or more recommended work area suggestions:
 - Ionizing fan setup
 - ESD table/shelf mat made of conductive materials
 - ESD safe storage containers
- One or more personnel suggestion options:
 - Antistatic Wrist-strap
 - Antistatic material shoes
 - Antistatic clothes
- Environmental controls
 - Humidity control (ESD gets worse in a dry environment)

b. EOS (Electrical Over Stress)

Electrical Over-Stress (EOS) is defined as damage that may occur when an electronic device is subjected to a current or voltage that is beyond the maximum specification limits of the device.

The effects from an EOS event can be noticed through product performance like:

- Changes to the performance of the LED package (If the damage is around the bond pad area and since the package is completely encapsulated the package may turn on but flicker show severe performance degradation.)
- Changes to the light output of the luminaire from component failure
- Components on the board not operating at determined drive power
- Failure of performance from entire fixture due to changes in circuit voltage and current across total circuit causing trickle down failures

It is impossible to predict the failure mode of every LED exposed to electrical overstress as the failure modes have been investigated to vary, but there are some common signs that will indicate an EOS event has occurred.

- Damaged may be noticed to the bond wires (appearing similar to a blown fuse)
- Damage to the bond pads located on the emission surface of the LED package (shadowing can be noticed around the bond pads while viewing through a microscope)
- Anomalies noticed in the encapsulation and phosphor around the bond wires.
 - This damage usually appears due to the thermal stress produced during the EOS event.

To help minimize the damage from an EOS event Seoul Semiconductor recommends utilizing:

- A surge protection circuit
 - An appropriately rated over voltage protection device
 - A current limiting device



Company Information

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Company Information

Seoul Semiconductor (www.SeoulSemicon.com) manufacturers and packages a wide selection of light emitting diodes (LEDs) for the automotive, general illumination/lighting, Home appliance, signage and back lighting markets. The company is the world's fifth largest LED supplier, holding more than 10,000 patents globally, while offering a wide range of LED technology and production capacity in areas such as "nPola", "Acrich", the world's first commercially produced AC LED, and "Acrich MJT - Multi-Junction Technology" a proprietary family of high-voltage LEDs.

The company's broad product portfolio includes a wide array of package and device choices such as Acrich and Acirch2, high-brightness LEDs, mid-power LEDs, side-view LEDs, and through-hole type LEDs as well as custom modules, displays, and sensors.

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